

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6236883

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YANG WU	07/30/2020
PING-SAN TZENG	07/30/2020
GENG BAI	07/31/2020
CHAO-YUNG WANG	07/31/2020
WEN KUNG CHU	07/30/2020
RECEIVING PARTY DATA	
Name:	AVATAR INTEGRATED SYSTEMS, INC.
Street Address:	2111 TASMAN DRIVE
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16915549
CORRESPONDENCE DATA	
Fax Number:	(408)973-2595
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	408-973-2585
Email:	sgarrido@ip-patent.com
Correspondent Name:	VAN PELT, YI & JAMES LLP
Address Line 1:	10050 N. FOOTHILL BLVD.
Address Line 2:	SUITE 200
Address Line 4:	CUPERTINO, CALIFORNIA 95014
ATTORNEY DOCKET NUMBER:	AVATP008
NAME OF SUBMITTER:	DIANA Y. FU
SIGNATURE:	/Diana Y. Fu/
DATE SIGNED:	08/05/2020
Total Attachments: 6	

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ASSIGNMENT OF PATENT APPLICATION

Whereas I/we the undersigned inventor(s) have invented certain new and useful improvements as set forth in the patent application entitled:

INTEGRATED SIMULATOR AND ANALYSIS AND OPTIMIZATION ENGINE

for which I (we) have executed an application for a United States Letters Patent which was filed in the U.S. Patent and Trademark Office on June 29, 2020, and which bears the Application No. 16/915,549 (the "APPLICATION");

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/we the undersigned inventor(s) hereby:

- 1) Sell, assign, and transfer to Avatar Integrated Systems, Inc., a Delaware corporation having a place of business at 2111 Tasman Drive, Santa Clara, CA 95054, United States of America, (hereinafter referred to as "ASSIGNEE"), the entire worldwide right, title and interest in and to: (a) the APPLICATION; (b) any application to which the APPLICATION claims priority and any application at least in part based upon the APPLICATION; (c) all provisional, utility, divisional, continuation, continuation-in-part, substitute, renewal, reissue, and other applications related thereto which have been or may be filed in the United States or elsewhere in the world; (d) all patents (including reissues and re-examinations) which may be granted on the applications set forth in (a), (b), and (c) above; (e) any and all improvements and inventions disclosed in (a), (b), (c), and (d) above; (f) all rights of priority in the APPLICATION and in any underlying provisional or foreign application, together with all rights to recover damages for infringement of any provisional rights; and (g) all claims for past, present and future infringement of any patent in (d) above, including all rights to sue for and to receive and recover for the ASSIGNEE's own use all past, present, and future lost profits, royalties, and damages of whatever nature recoverable from an infringement of any patent in (d) above.
- 2) Authorize and request the issuance of any and all patent(s) resulting from said application or any division(s), continuation(s), continuation-in-part(s), substitutes(s), reissue(s), or other application(s) related thereof, which have been or may be filed in the United States or elsewhere in the world, to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said APPLICATION, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications. Such acts shall include (a) executing all oaths, assignments, powers of attorney, applications, and other papers necessary or desirable to fully secure to the ASSIGNEE the rights, titles and interests herein conveyed; (b) communicating to the ASSIGNEE all known facts relating to any subject matter disclosed in the APPLICATION or any application or patent related to the APPLICATION; and (c) generally doing all lawful acts that the ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection and for vesting in the ASSIGNEE the rights, titles, and interests herein conveyed.

4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative, and shall be binding upon the inventor(s), as well as the inventor's heirs, legal representatives and assigns.

5) Warrant and represent that I/we have the rights, titles, and interests to convey as set forth herein, and have not entered, and will not enter into any assignment, grant, mortgage, license, contract, agreement, or understanding that conflicts with this assignment.

Signed on the date(s) indicated beside my (our) signature(s).

Full name of inventor	Yang Wu	
Signature of inventor	/  /	Date: 7/30/2020

Full name of inventor	Ping-San Tzeng	
Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Geng Bai	
Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Chao-Yung Wang	
Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Wen Kung Chu	
Signature of inventor	/ _____ /	Date: _____

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Full name of inventor	Yang Wu	
Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Ping-San Tzeng	
Signature of inventor	/ <i>Ping San Tzeng</i> /	Date: <u>Jul 30, 2020</u>

Full name of inventor	Geng Bai	
Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Chao-Yung Wang	
Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Wen Kung Chu	
Signature of inventor	/ _____ /	Date: _____

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Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Geng Bai	
Signature of inventor	/ Bai Geng /	Date: 07/31/2020

Full name of inventor	Chao-Yung Wang	
Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Wen Kung Chu	
Signature of inventor	/ _____ /	Date: _____

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Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Geng Bai	
Signature of inventor	/ Bai Geng /	Date: 07/31/2020

Full name of inventor	Chao-Yung Wang	
Signature of inventor	/ Chao Yung Wang /	Date: 7/31/2020

Full name of inventor	Wen Kung Chu	
Signature of inventor	/ _____ /	Date: _____

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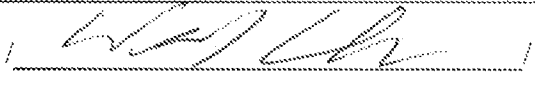
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Full name of inventor	Yang Wu	
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Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Chao-Yung Wang	
Signature of inventor	/ _____ /	Date: _____

Full name of inventor	Wen Kung Chu	
Signature of inventor	/  /	Date: 07/30/2020